

Rec'd PCT/PTO 10 NOV 2005 #4
10/522502

Serial No. 10/522,502
Infineon Ref No. FIN 404 PCT/US
OC Ref No. 1431.124.101

**DECLARATION FOR PATENT APPLICATION, POWER OF
ATTORNEY & DESIGNATION OF CORRESPONDENCE ADDRESS**

As below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**SEMICONDUCTOR WAFER WITH ELECTRICALLY
CONNECTED CONTACT AND TEST AREAS**

the specification of which (check one)

___ is attached hereto.

X was filed on July 29, 2003 as PCT International Application Number PCT/DE03/02544, which entered the U.S. National Stage on January 26, 2005 under U.S. Application No. 10/522,502.

I hereby state that I have reviewed and understand the contents of the above-identified specification including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me to be material to the patentability of this application in accordance with 37 CFR §1.56(a).

**PRIOR FOREIGN/PCT APPLICATION(S) FILED WITHIN 12 MONTHS (6 MONTHS FOR
DESIGN) PRIOR TO THIS APPLICATION AND ANY PRIORITY CLAIMS UNDER 35
U.S.C. § 119(a)-(d)**

I hereby claim foreign priority benefits under 35 USC § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
Number	Country	Day/Month/Year Filed	Yes	No
102 34 648.8	DE	29/07/2002	X	

CLAIM FOR BENEFIT OF PRIOR U.S. PROVISIONAL APPLICATION(S)
(35 U.S.C. § 119(e))

I hereby claim the benefit under Title 35, United States Code, § 119 (e) of any United States provisional application(s) listed below:

Provisional Application Number	Filing Date

CLAIM FOR BENEFIT OF EARLIER US/PCT APPLICATION(S)
UNDER 35 U.S.C. § 120

I hereby claim the benefits under 35 USC § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 USC § 112, I acknowledge the duty to disclose material information as defined in 37 CFR § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Appl. No.	Filing Date	Patented, Pending, Abandoned
PCT/DE03/02544	29/07/2003	Pending

Power of Attorney: As a named inventor, I hereby appoint the practitioners under Customer Number

45782

jointly, and each of them severally, my attorneys at law/patent agent(s), with full power of substitution, delegation and revocation, to prosecute this application and any continuations, divisions, reissues, and reexaminations thereof, to receive the patent(s), to transact all business in the United States Patent and Trademark Office connected therewith and to act on my behalf before the competent International Authorities in connection with any and all international applications filed.

Send correspondence to:

025281

Direct telephone calls to:

Steven E. Dicke

(612) 573-2002

I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1-00

Full Name of First Inventor: <u>Werner Ertle</u>	
Inventor's Signature: <u>[Signature]</u>	Date: <u>29/04/05</u>
Residence: <u>Pfarrer-Sickinger-Weg 128, 85579 Neubiberg, Germany</u>	
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Mailing Address: <u>Same as Above</u>	

2-00

Full Name of Second Inventor: <u>Bernd Gollen</u>	
Inventor's Signature: <u>[Signature]</u>	Date: <u>28/04/05</u>
Residence: <u>Bahnhofstr. 28 r, 83624 Otterfing, Germany</u>	
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Full Name of Third Inventor: <u>Michael Horn</u>	
Inventor's Signature:	Date:
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Full Name of Fourth Inventor: <u>Bernd Kothe</u>	
Inventor's Signature:	Date:
Residence: <u>Zugspitzstr. 40, 85560 Ebersberg, Germany</u>	
Citizenship: <u>Germany</u>	
Mailing Address: <u>Same as Above</u>	

I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or Imprisonment, or both under 18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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Full Name of Second Inventor: Bernd Goller	
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3-00

Full Name of Third Inventor: Michael Horn	
Inventor's Signature: <i>Michael Horn</i>	Date: 14-04-2005
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I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of First Inventor: Werner Ertle	
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Full Name of Second Inventor: Bernd Goller	
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Full Name of Third Inventor: Michael Horn	
Inventor's Signature:	Date:
Residence: St. Magnusstr. 2, 81545 Munchen, Germany	
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Full Name of Fourth Inventor: Bernd Kothe	
Inventor's Signature: <i>Bernd Kothe</i>	Date: <i>04/15/2005</i>
Residence: Zugspitzstr. 40, 85560 Ebersberg, Germany *	
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* new residence :

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France

FRx

Rec'd PCT/PTO

10 NOV 2005

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INFINEON REF NO FIN 404 PCT/US
O.C. REF NO. I431.124.101

ASSIGNMENT

For good and valuable consideration, I, Werner Ertle, a citizen of Germany, residing at Pfarrer-Sickinger-Weg 128, 85579 Neubiberg, Germany; Bernd Goller, a citizen of Germany, residing at Bahnhofstr. 28 r, 83624 Otterfing, Germany; Michael Horn, a citizen of Germany, residing at St. Magnusstr. 2, 81545 Munchen, Germany; and Bernd Kothe, a citizen of Germany, ~~residing at Zugspitzstr. 40, 85560 Ebersberg, Germany~~, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81541, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and may be identified in the United States Patent Office by International Application Number PCT/DE03/02544, which entered the U.S. National Stage on January 26, 2005 under U.S. Application No. 10/522,502,

entitled: SEMICONDUCTOR WAFER WITH ELECTRICALLY CONNECTED CONTACT
AND TEST AREAS

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: _____ DATE: _____
NAME: Werner Ertle